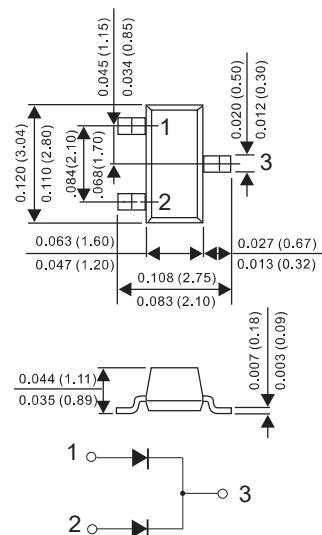
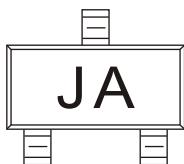


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FEATURES

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automatic Insertion
- For General Purpose Switching Applications
- High Conductance

Marking: JA



Dimensions in inches and (millimeters)

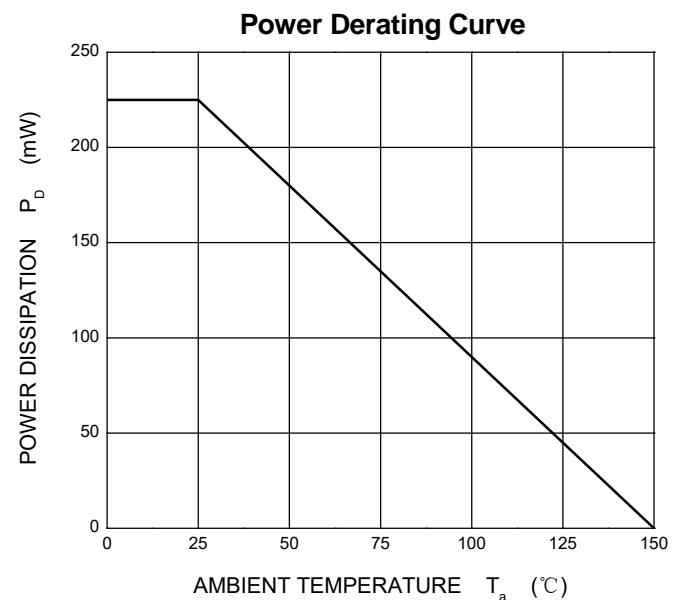
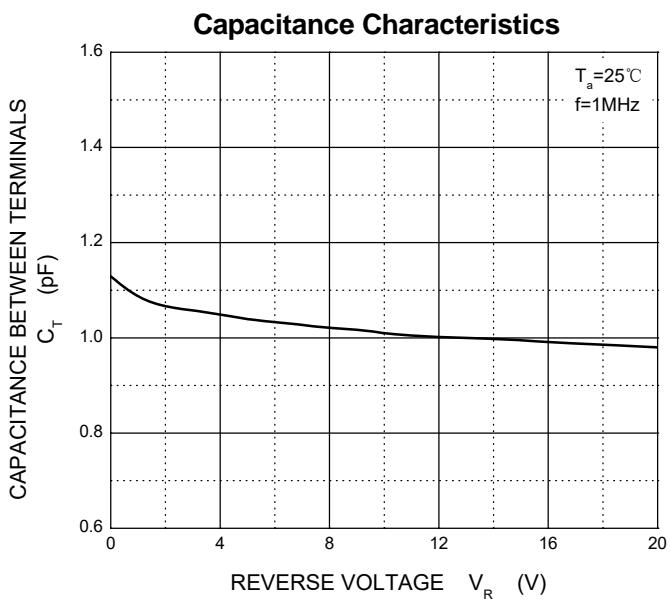
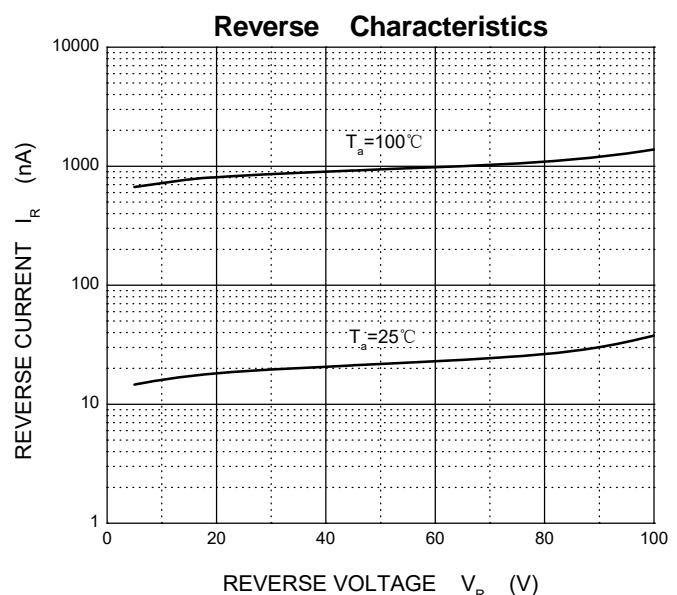
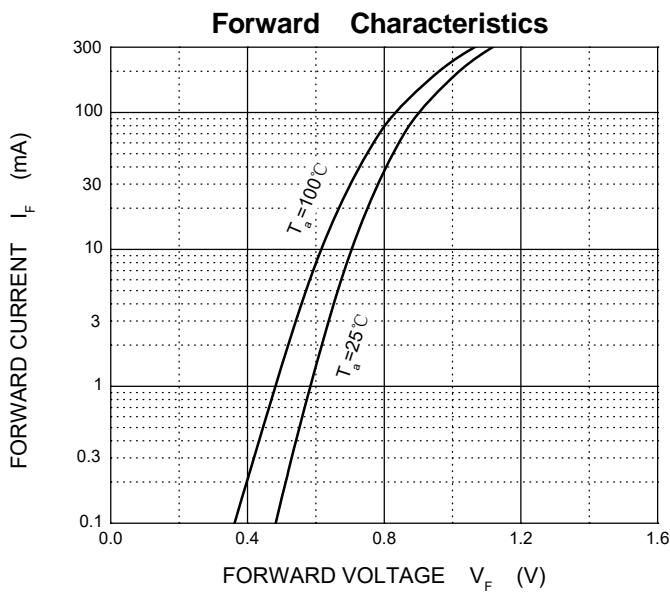
Maximum Ratings @Ta=25°C

Parameter	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V _{RM}	50	V
DC Blocking Voltage	V _R		
Average Rectified Output Current	I _O	200	mA
Non-Repetitive Peak Forward Surge Current @t=8.3ms	I _{FSM}	2.0	A
Power Dissipation	P _D	225	mW
Thermal Resistance From Junction to Ambient	R _{θJA}	556	°C/W
Operation Junction and Storage Temperature Range	T _J , T _{STG}	-55~+150	°C

ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)

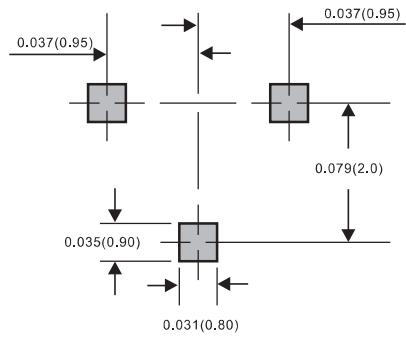
Parameter	Symbol	Test conditions	Min	Max	Unit
Reverse breakdown voltage	V _(BR)	I _R = 5µA	50		V
Reverse voltage leakage current	I _R	V _R =50V		0.1	µA
Forward voltage	V _F	I _F =100mA		1	V
Diode Capacitance	C _D	V _R =0, f=1MHz		2	pF
Reveres recovery time	t _{rr}	I _F =I _R =10mA, R _L =100Ω, I _{rr} =0.1×I _R		4	ns

Typical Characteristics



Suggested solder pad layout

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Dimensions in inches and (millimeters)